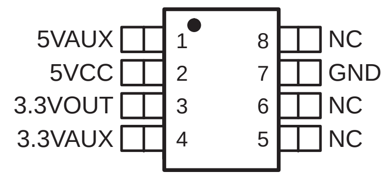
- **Automatic Input Voltage Source Selection**
- **Glitch-Free Regulated Output**
- **5-V Input Voltage Source Detector With Hysteresis**
- **250-mA Load Current Capability With 5-V or 3.3-V Input Source**
- **Low $r_{DS(on)}$ Auxiliary Switch**

D PACKAGE
(TOP VIEW)



description

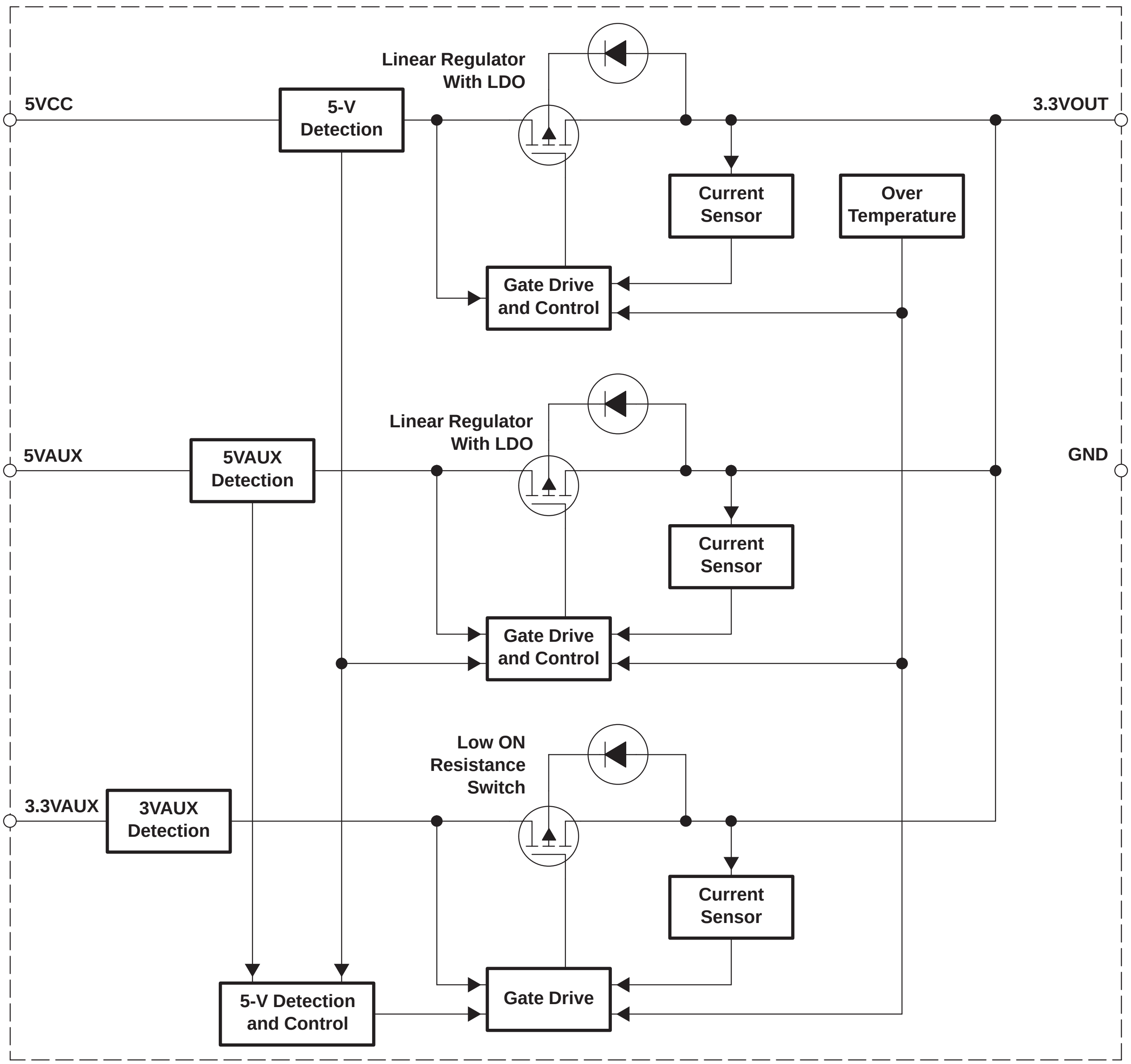
The TPPM0303 is a low-dropout regulator with auxiliary power management that provides a constant 3.3-V supply at the output capable of driving a 250-mA load.

The TPPM0303 provides a regulated power output for systems that have multiple input sources and require a constant voltage source with a low-dropout voltage. This is a single output, multiple input, intelligent power source selection device with a low-dropout regulator for either 5VCC or 5VAUX inputs, and a low-resistance bypass switch for the 3.3VAUX input.

Transitions may occur from one input supply to another without generating a glitch outside of the specification range on the 3.3-V output. The device has an incorporated reverse-blocking scheme to prevent excess leakage from the input terminals in the event that the output voltage is greater than the input voltage.

The input voltage is prioritized in the following order: 5VCC, 5VAUX, and 3.3VAUX.

functional block diagram



Terminal Functions

TERMINAL NAME	TERMINAL NO.	I/O	DESCRIPTION
3.3VAUX	4	I	3.3-V auxiliary input
3.3VOUT	3	O	3.3-V output with a typical capacitance load of 4.7 µF
5VAUX	1	I	5-V auxiliary input
5VCC	2	I	5-V main input
GND	7	I	Ground
NC	5,6,8		No internal connection

Table 1. Input Selection

INPUT VOLTAGE STATUS (V)			INPUT SELECTED	OUTPUT (V)	OUTPUT (I)
5VCC	5VAUX	3.3VAUX	5VCC/5VAUX/3.3VAUX	3.3VOUT	I_L (mA)
0	0	0	None	0	0
0	0	3.3	3.3VAUX	3.3	250
0	5	0	5VAUX	3.3	250
0	5	3.3	5VAUX	3.3	250
5	0	0	5VCC	3.3	250
5	0	3.3	5VCC	3.3	250
5	5	0	5VCC	3.3	250
5	5	3.3	5VCC	3.3	250

absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

Supply voltage, 5-V main input, $V_{(5VCC)}$ (see Notes 1 and 2) . . . . 7 V
Auxiliary voltage, 5-V input, $V_{(5VAUX)}$ (see Notes 1 and 2) . . . . 7 V
Auxiliary voltage, 3.3-V input, $V_{(3.3VAUX)}$ (see Notes 1 and 2) . . . . 5 V
3.3-V output current limit, $I_{(LIMIT)}$ . . . . 1.5 A
Continuous power dissipation (low-K), P_D (see Note 3) . . . . 0.625 W
Electrostatic discharge susceptibility, human body model, $V_{(HBMESD)}$ . . . . 2 kV
Operating ambient temperature range, T_A . . . . 0°C to 70°C
Storage temperature range, T_{stg} . . . . –55°C to 150°C
Operating junction temperature range, T_J . . . . –5°C to 120°C
Lead temperature (soldering, 10 second), $T_{(LEAD)}$ . . . . 260°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values are with respect to GND.
2. Absolute negative voltage on these terminal should not be below –0.5 V.
3. The device derates with increase in ambient temperature, T_A. See Thermal Information section.

recommended operating conditions

	MIN	TYP	MAX	UNIT
5-V main input, $V_{(5VCC)}$	4.5		5.5	V
5-V auxiliary input, $V_{(5VAUX)}$	4.5		5.5	V
3.3-V auxiliary input, $V_{(3.3VAUX)}$	3		3.6	V
Load capacitance, C_L	4.23	4.7	5.17	µF
Load current, I_L	0		250	mA
Ambient temperature, T_A	0		70	°C

electrical characteristics over recommended operating free-air temperature range, T_A = 0°C to 70°C, C_L = 4.7 μF (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{(5VCC)}$/ $V_{(5VAUX)}$	5-V inputs		4.5	5	5.5	V
$I_{(Q)}$	Quiescent supply current	From 5VCC or 5VAUX terminals, I_L = 0 to 250 mA		2.5	5	mA
		From 3.3VAUX terminal, I_L = 0 A		250	500	μA
I_L	Output load current		0.25			A
$I_{(LIMIT)}$	Output current limit	3.3VOUT = 0 V			2	A
$T_{(TSD)}$†	Thermal shutdown	3.3VOUT output shorted to 0 V	150		180	°C
T_{hys}†	Thermal hysteresis	3.3VOUT output shorted to 0 V		15		°C
$V_{(3.3VOUT)}$	3.3-V output	I_L = 250 mA	3.135	3.3	3.465	V
C_L	Load capacitance	Minimal ESR to insure stability of regulated output		4.7		μF
$I_{lkg(REV)}$	Reverse leakage output current	Tested for input that is grounded. 3.3VAUX, 5VAUX or 5VCC = GND, 3.3VOUT = 3.3 V			50	μA

† Design targets only. Not tested in production.

5-V detect

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{(TO\_LO)}$	Threshold voltage, low	5VAUX or 5VCC ↓	3.85	4.05	4.25	V
$V_{(TO\_HI)}$	Threshold voltage, high	5VAUX or 5VCC ↑	4.1	4.3	4.5	V

auxiliary switch

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$R_{(SWITCH)}$	Auxiliary switch resistance	5VAUX = 5VCC = 0 V, 3.3VAUX = 3.3 V, I_L = 150 mA			0.4	Ω
$\Delta V_{O(\Delta VI)}$	Line regulation voltage	5VAUX or 5VCC = 4.5 V to 5.5 V		2		mV
$\Delta V_{O(\Delta IO)}$	Load regulation voltage	20 mA < I_L < 250 mA		40		mV
$V_I - V_O$	Dropout voltage	I_L < 250 mA			1	V

thermal characteristics

PARAMETER			MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Thermal impedance, junction-to-case				39	°C/W
$R_{\theta JA}$	Thermal impedance, junction-to-ambient	Low-K (see Note 4)			176	°C/W
		High-K (see Note 4)			98	°C/W

NOTE 4: See JEDEC PCB specifications for low-K and high-K.

TYPICAL CHARACTERISTICS

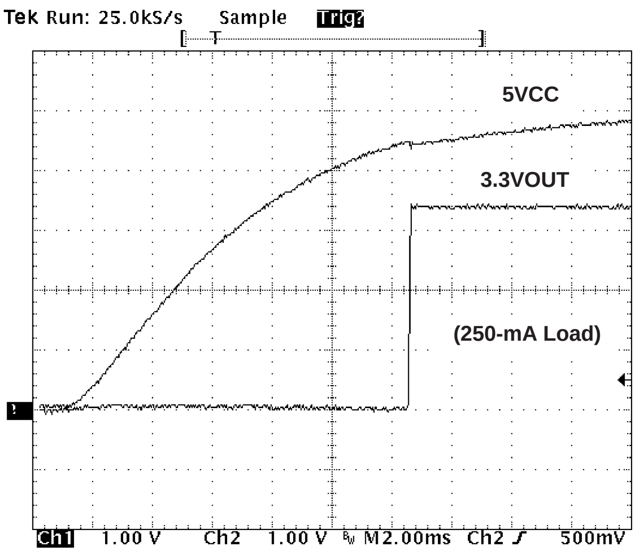


Figure 1. 5VCC Cold Start

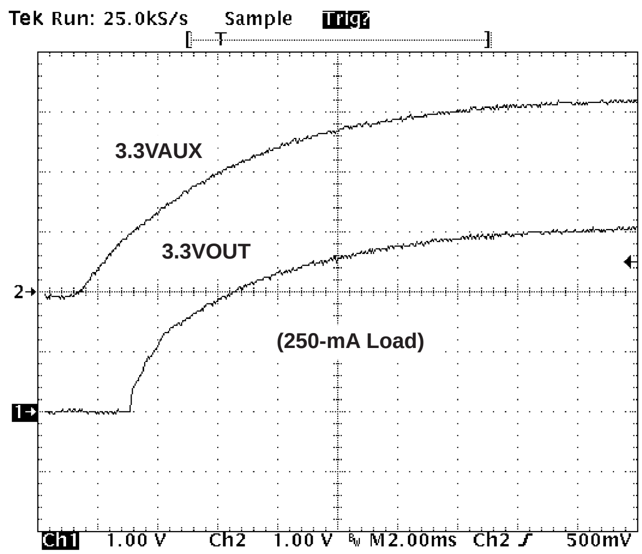


Figure 2. 3.3VAUX Cold Start

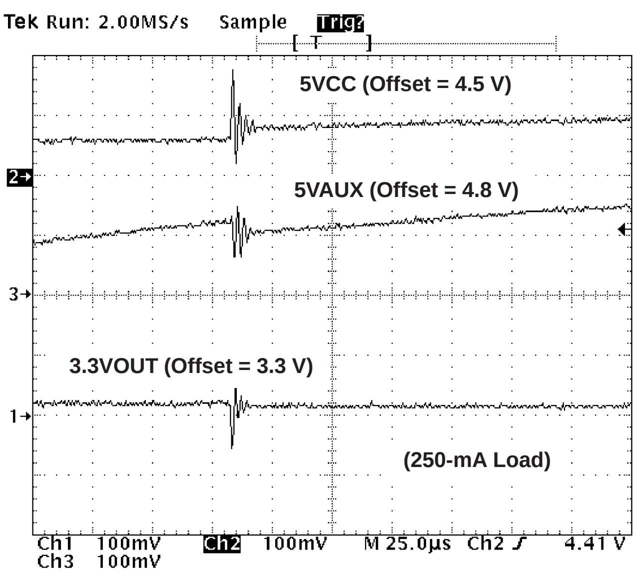


Figure 3. 5VCC Power Up (5VAUX = 5 V)

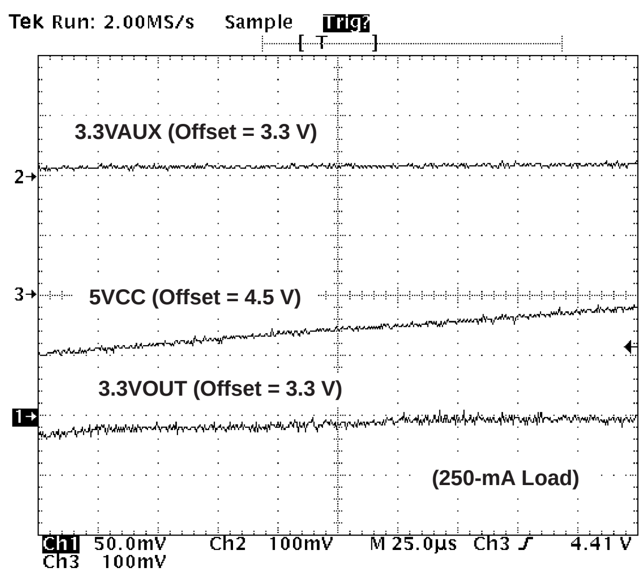


Figure 4. 5VCC Power Up (3.3VAUX = 3.3 V)

TYPICAL CHARACTERISTICS

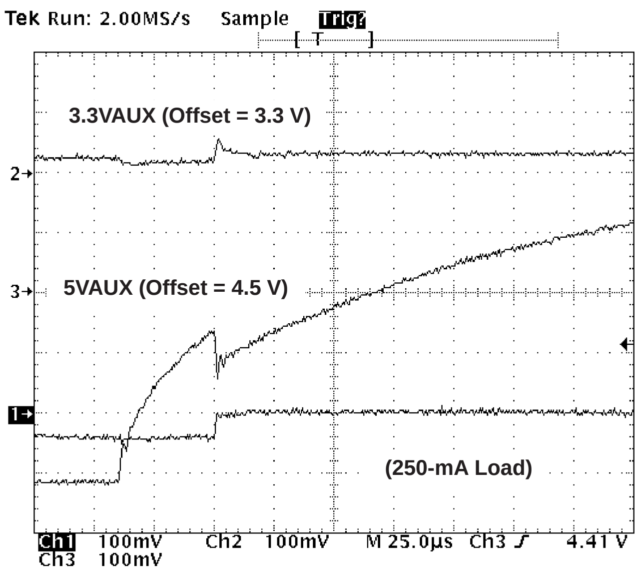


Figure 5. 5VAUX Power Up (3.3VAUX = 3.3 V)

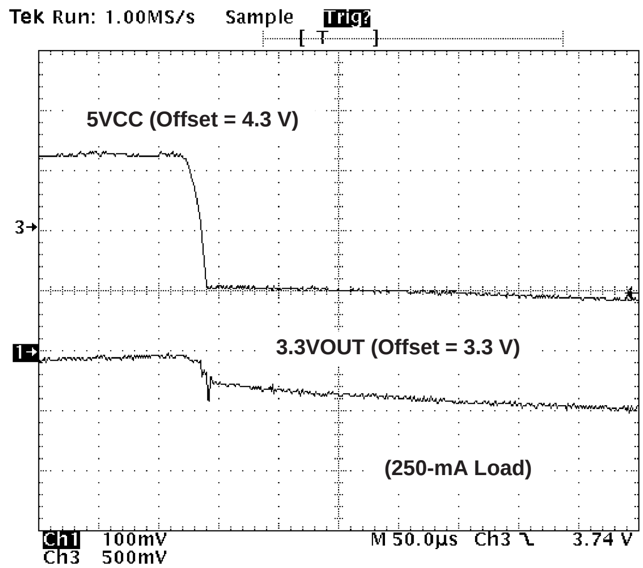


Figure 6. 5VCC Power Down (3.3VAUX = 3.3 V)

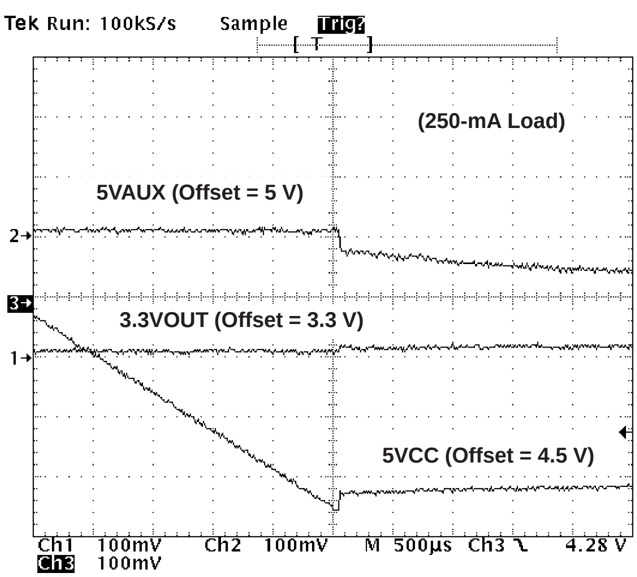


Figure 7. 5VCC Power Down (5VAUX = 5 V)

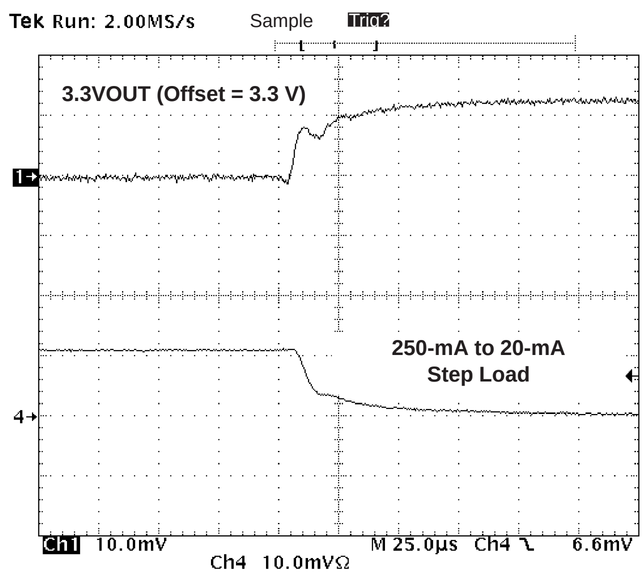


Figure 8. 5VCC Load Transient Response Falling

TYPICAL CHARACTERISTICS

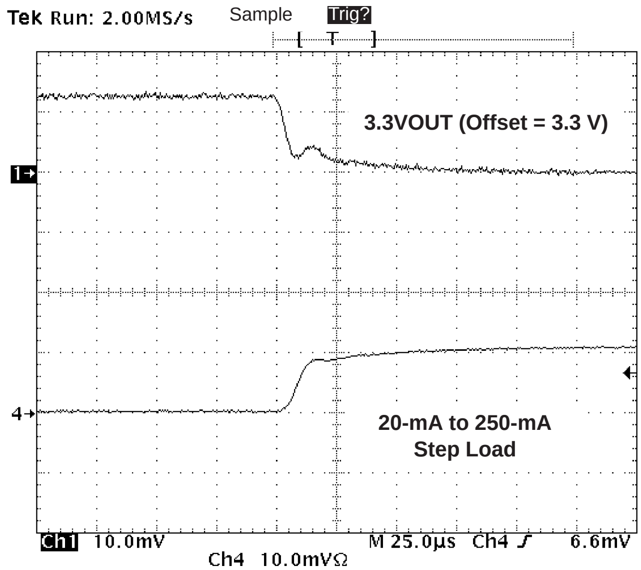


Figure 9. 5VCC Load Transient Response Rising

THERMAL INFORMATION

To ensure reliable operation of the device, the junction temperature of the output device must be within the safe operating area (SOA). This is achieved by having a means to dissipate the heat generated from the junction of the output structure. There are two components that contribute to thermal resistance. They consist of two paths in series. The first is the junction to case thermal resistance, $R_{\theta JC}$; the second is the case to ambient thermal resistance, $R_{\theta CA}$. The overall junction to ambient thermal resistance, $R_{\theta JA}$, is determined by:

$$R_{\theta JA} = R_{\theta JC} + R_{\theta CA}$$

The ability to efficiently dissipate the heat from the junction is a function of the package style and board layout incorporated in the application. The operating junction temperature is determined by the operating ambient temperature, T_A, and the junction power dissipation, P_J.

The junction temperature, T_J, is equal to the following thermal equation:

$$T_J = T_A + P_J\,(R_{\theta JC}) + P_J\,(R_{\theta CA})$$

$$T_J = T_A + P_J\,(R_{\theta JA})$$

This particular application uses the 8-pin SO package with standard lead frame with a dedicated ground terminal. Hence, the maximum power dissipation allowable for an operating ambient temperature of 70°C, and a maximum junction temperature of 150°C is determined as:

$$P_J = (T_J - T_A)/R_{\theta JA}$$

P_J = (150 – 70)/176 = 0.45 W when using a low-K PCB.

P_J = (150 – 70)/98 = 0.81 W when using a high-K PCB.

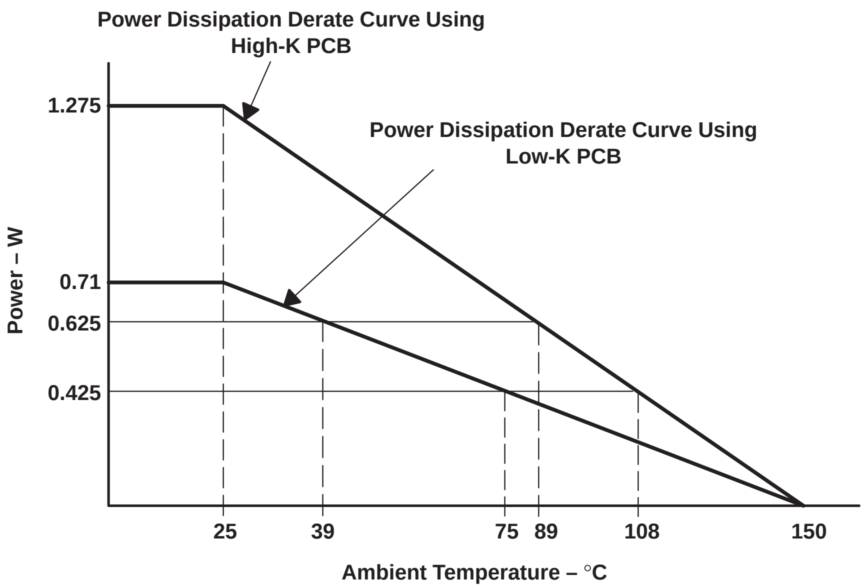
Worst case maximum power dissipation is determined by:

$$P_D = (5.5 - 3) \times 0.25 = 0.625\text{ W}$$

Normal operating maximum power dissipation is (see Figure 10):

$$P_D = (5 - 3.3) \times 0.25 = 0.425\text{ W}$$

THERMAL INFORMATION



NOTE: These curves are to be used for guideline purposes only. For a particular application, a more specific thermal characterization is required.

Figure 10. Power Dissipation Derating Curves

APPLICATION INFORMATION

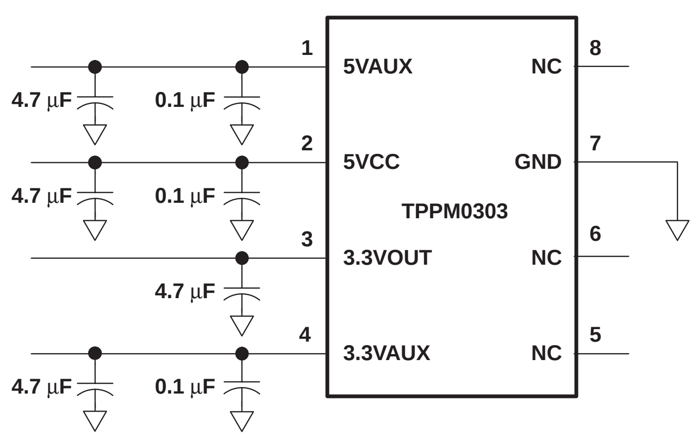
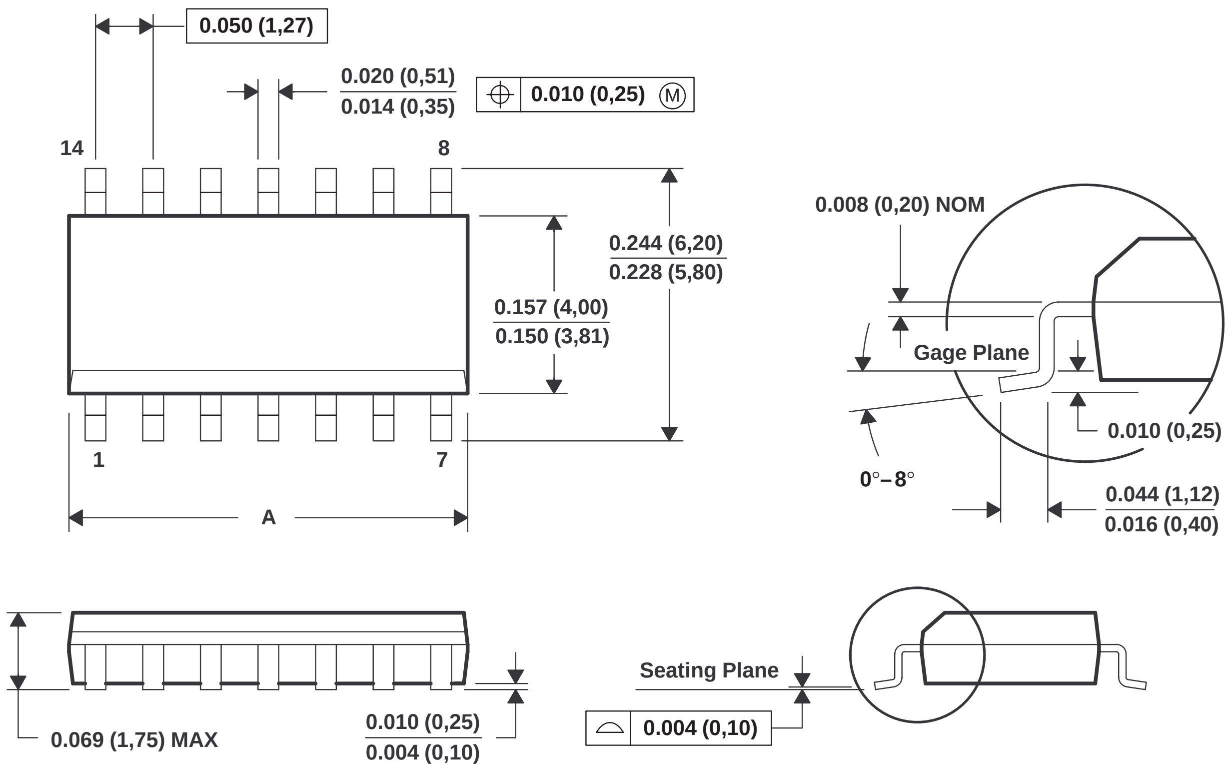


Figure 11. Typical Application Schematic

MECHANICAL DATA

D (R-PDSO-G)** **PLASTIC SMALL-OUTLINE PACKAGE**

14 PINS SHOWN



PINS ** / DIM	8	14	16
A MAX	0.197 (5,00)	0.344 (8,75)	0.394 (10,00)
A MIN	0.189 (4,80)	0.337 (8,55)	0.386 (9,80)

4040047/D 10/96

NOTES:
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012

IMPORTANT NOTICE

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